muRata

Reference Specification

DEB Series

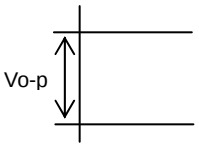
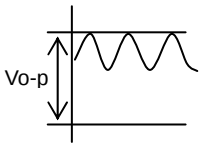
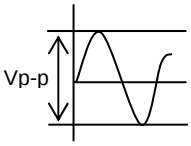
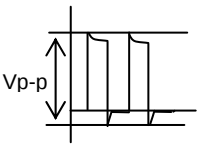
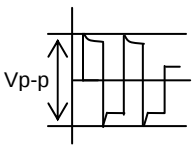
Lead Type Disc Ceramic Capacitors of Class 2 for General Purpose

Product specifications in this catalog are as of Dec. 2017, and are subject to change or obsolescence without notice.
Please consult the approval sheet before ordering.Please read rating and Cautions first.

⚠ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.
When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.
When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage(1)	Pulse Voltage(2)
Positional Measurement					

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.
When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. The allowable frequency should be in less than 300kHz in sine wave. Applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C. When measuring, use a thermocouple of small thermal capacity-K of ϕ0.1mm and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. While, in case of non-sine wave which include a harmonic frequency, please contact our sales representatives or product engineers.

3. FAIL-SAFE

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

4. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

5. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.
When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron tip : 400 °C max.
Soldering iron wattage : 50W max.
Soldering time : 3.5 s max.

6. BONDING, RESIN MOLDING AND COATING

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

7. TREATMENT AFTER BONDING, RESIN MOLDING AND COATING

When the outer coating is hot (over 100 ℃) after soldering, it becomes soft and fragile.
So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

8. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors
in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 °C and 15 to 85%. Use capacitors within 6 months after delivered.
Check the solderability after 6 months or more.

9. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

1. Aircraft equipment
2. Aerospace equipment
3. Undersea equipment
4. Power plant control equipment
5. Medical equipment
6. Transportation equipment (vehicles, trains, ships, etc.)
7. Traffic signal equipment
8. Disaster prevention / crime prevention equipment
9. Data-processing equipment exerting influence on public
10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions.
Rinse bath capacity : Output of 20 watts per liter or less.
Rinsing time : 5 min maximum.
Do not vibrate the PCB/PWB directly.
Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. CAPACITANCE CHANGE OF CAPACITORS

- Class 1 capacitors
  Capacitance might change a little depending on a surrounding temperature or an applied voltage.
  Please contact us if you use for the strict time constant circuit.
- Class 2 and 3 capacitors
  Class 2 and 3 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.
  Please contact us if you need a detail information.

⚠ NOTE

1.Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
2.You are requested not to use our product deviating from this specification.

1. Application

This specification is applied to Lead Type Disc Ceramic Capacitors of DC2kV ～3.15kV ratings and Class 2 of DEB series used for General Electric equipment.

Do not use these products in any automotive power train or safety equipment including battery chargers for electric vehicles and plug-in hybrids.

2. Rating

2-1. Operating temperature range

-25 ~ +85°C

2-2. Part number configuration

ex.)	DEB	B3	3D	332	K	A3	B	
	Series	Temperature characteristic	Rated voltage	Capacitance	Capacitance tolerance	Lead code	Packing style code	Individual specification

•Temperature characteristic

Code	Temperature characteristic
B3	B
E3	E
F3	F

Please confirm detailed specification on [Specification and test methods].

• Rated voltage

Code	Rated voltage
3D	DC2kV
3F	DC3.15kV

• Capacitance

The first two digits denote significant figures ; the last digit denotes the multiplier of 10 in pF.

ex.) In case of 332.

$33 \times 10^2 = 3300pF$

• Capacitance tolerance

Please refer to [Part number list].

• Lead code

Code	Lead style
A∗	Vertical crimp long type
C∗	Straight long type
B∗	Vertical crimp short type
D∗	Straight short type
N∗	Vertical crimp taping type
P∗	Straight taping type

∗ Please refer to [Part number list].

Solder coated copper wire is applied for termination.

- Packing style code

Code	Packing type
B	Bulk type
A	Ammo pack taping type

- Individual specification

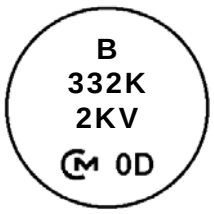
  In case part number cannot be identified without 'individual specification' , it is added at the end of part number.

3. Marking

Temperature characteristic : Letter code
Identified by code for char. B or char. E.
(Omitted for maximum body diameter ϕ 9mm and under)
Nominal capacitance : 3 digit system
Capacitance tolerance : Code(Omitted for maximum body diameter ϕ 6mm and under)
Rated voltage : Letter code(In case of DC3.15kV, marked with 3KV)
Company name code : Abbreviation
(Omitted for maximum body diameter ϕ 9mm and under)
Manufacturing year : Letter code(The last digit of A.D. year.)
(Omitted for maximum body diameter ϕ 5mm and under)
Manufacturing month : Code(Omitted for maximum body diameter ϕ 5mm and under)

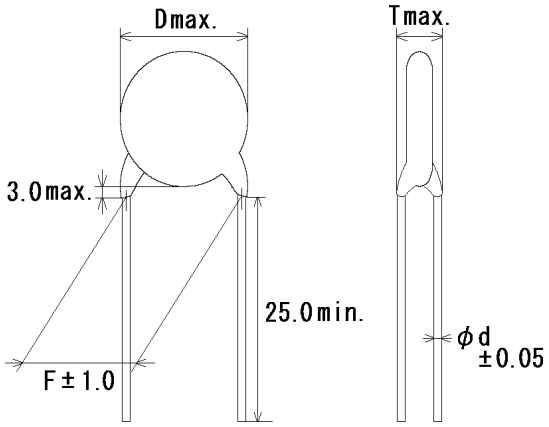
Feb./Mar. → 2	Aug./Sep. → 8
Apr./May → 4	Oct./Nov. → O
Jun./Jul. → 6	Dec./Jan. → D

(Example)

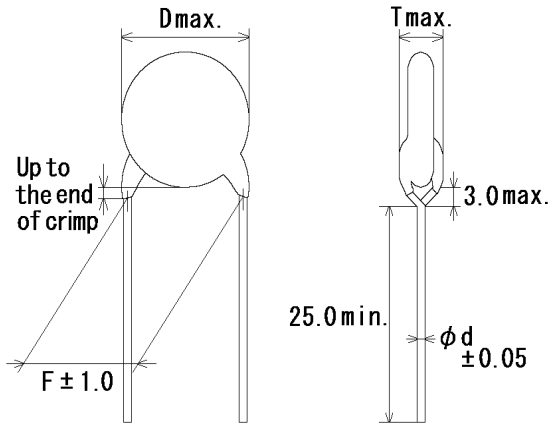


4. Part number list

・Straight long type
(Lead code:C*)



・Vertical crimp long type
(Lead code:A*)

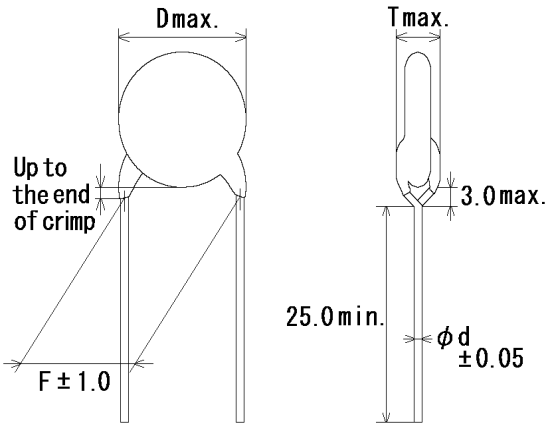


Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

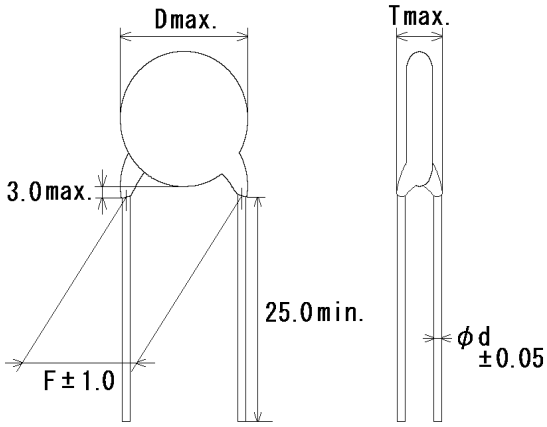
Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated Volt. (V)	Dimension (mm)				Lead Code	Pack qty. (pcs)
						D	T	F	d		
B	100	±10%		DEBB33D101KC1B	2000	4.5	5.0	5.0	0.5	C1	500
B	150	±10%		DEBB33D151KC1B	2000	4.5	5.0	5.0	0.5	C1	500
B	220	±10%		DEBB33D221KC1B	2000	4.5	5.0	5.0	0.5	C1	500
B	330	±10%		DEBB33D331KC1B	2000	5.0	5.0	5.0	0.5	C1	500
B	470	±10%		DEBB33D471KA2B	2000	6.0	5.0	5.0	0.6	A2	500
B	680	±10%		DEBB33D681KA2B	2000	7.0	5.0	5.0	0.6	A2	500
B	1000	±10%		DEBB33D102KA2B	2000	8.0	5.0	5.0	0.6	A2	250
B	1500	±10%		DEBB33D152KA2B	2000	9.0	5.0	5.0	0.6	A2	250
B	2200	±10%		DEBB33D222KA2B	2000	10.0	5.0	5.0	0.6	A2	250
B	3300	±10%		DEBB33D332KA3B	2000	12.0	5.0	7.5	0.6	A3	200
B	4700	±10%		DEBB33D472KA3B	2000	15.0	5.0	7.5	0.6	A3	100
B	100	±10%		DEBB33F101KCDB	3150	5.0	6.0	7.5	0.5	CD	500
B	150	±10%		DEBB33F151KCDB	3150	5.0	6.0	7.5	0.5	CD	500
B	220	±10%		DEBB33F221KCDB	3150	5.0	6.0	7.5	0.5	CD	500
B	330	±10%		DEBB33F331KC3B	3150	6.0	6.0	7.5	0.6	C3	500
B	470	±10%		DEBB33F471KC3B	3150	7.0	6.0	7.5	0.6	C3	250
B	680	±10%		DEBB33F681KA3B	3150	8.0	6.0	7.5	0.6	A3	250
B	1000	±10%		DEBB33F102KA3B	3150	9.0	6.0	7.5	0.6	A3	250
B	1500	±10%		DEBB33F152KA3B	3150	11.0	6.0	7.5	0.6	A3	250
B	2200	±10%		DEBB33F222KA3B	3150	13.0	6.0	7.5	0.6	A3	200
B	3300	±10%		DEBB33F332KA3B	3150	15.0	6.0	7.5	0.6	A3	100
E	1000	+80/-20%		DEBE33D102ZA2B	2000	6.0	5.0	5.0	0.6	A2	500
E	2200	+80/-20%		DEBE33D222ZA2B	2000	8.0	5.0	5.0	0.6	A2	250
E	4700	+80/-20%		DEBE33D472ZA2B	2000	11.0	5.0	5.0	0.6	A2	250
E	10000	+80/-20%		DEBE33D103ZA3B	2000	16.0	5.0	7.5	0.6	A3	100
E	1000	+80/-20%		DEBE33F102ZC3B	3150	7.0	6.0	7.5	0.6	C3	250
E	2200	+80/-20%		DEBE33F222ZA3B	3150	10.0	6.0	7.5	0.6	A3	250

・Vertical crimp long type
(Lead code:A*)



・Straight long type
(Lead code:C*)



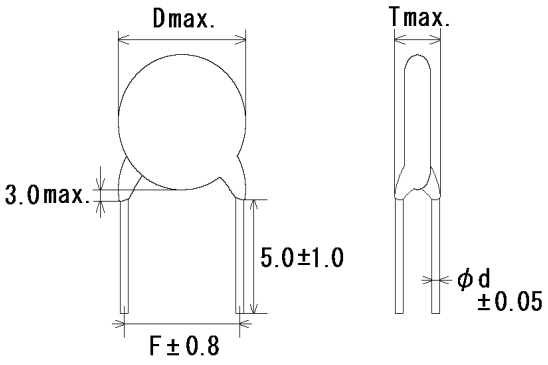
Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

Unit : mm

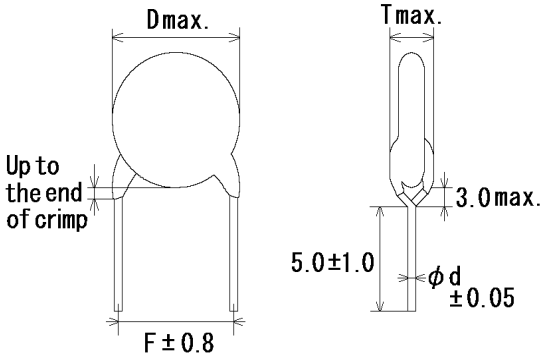
T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated Volt. (V)	Dimension (mm)				Lead Code	Pack qty. (pcs)
						D	T	F	d		
E	4700	+80/-20%		DEBE33F472ZA3B	3150	13.0	6.0	7.5	0.6	A3	200
F	1000	+80/-20%		DEBF33D102ZC1B	2000	5.0	5.0	5.0	0.5	C1	500
F	2200	+80/-20%		DEBF33D222ZA2B	2000	7.0	5.0	5.0	0.6	A2	500
F	4700	+80/-20%		DEBF33D472ZA2B	2000	9.0	5.0	5.0	0.6	A2	250
F	10000	+80/-20%		DEBF33D103ZA3B	2000	12.0	5.0	7.5	0.6	A3	200

Reference only

·Straight short type
(Lead code:D*)



·Vertical crimp short type
(Lead code:B*)

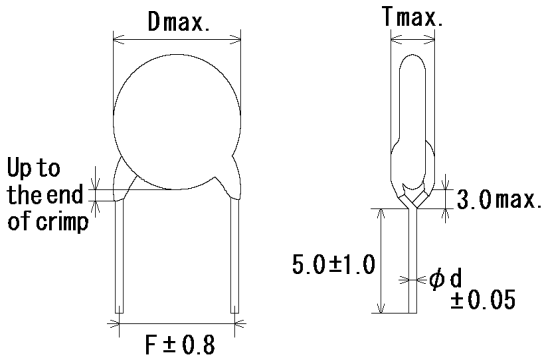


Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

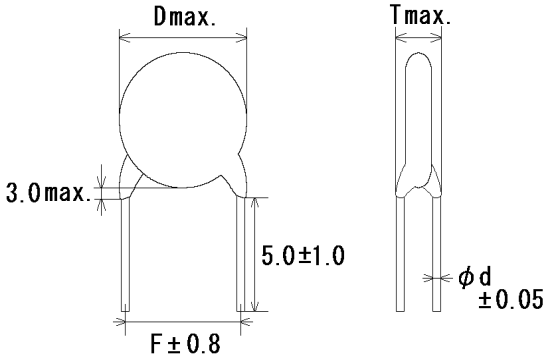
Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated Volt. (V)	Dimension (mm)				Lead Code	Pack qty. (pcs)
						D	T	F	d		
B	100	±10%		DEBB33D101KD1B	2000	4.5	5.0	5.0	0.5	D1	500
B	150	±10%		DEBB33D151KD1B	2000	4.5	5.0	5.0	0.5	D1	500
B	220	±10%		DEBB33D221KD1B	2000	4.5	5.0	5.0	0.5	D1	500
B	330	±10%		DEBB33D331KD1B	2000	5.0	5.0	5.0	0.5	D1	500
B	470	±10%		DEBB33D471KB2B	2000	6.0	5.0	5.0	0.6	B2	500
B	680	±10%		DEBB33D681KB2B	2000	7.0	5.0	5.0	0.6	B2	500
B	1000	±10%		DEBB33D102KB2B	2000	8.0	5.0	5.0	0.6	B2	500
B	1500	±10%		DEBB33D152KB2B	2000	9.0	5.0	5.0	0.6	B2	500
B	2200	±10%		DEBB33D222KB2B	2000	10.0	5.0	5.0	0.6	B2	500
B	3300	±10%		DEBB33D332KB3B	2000	12.0	5.0	7.5	0.6	B3	250
B	4700	±10%		DEBB33D472KB3B	2000	15.0	5.0	7.5	0.6	B3	200
B	100	±10%		DEBB33F101KDDB	3150	5.0	6.0	7.5	0.5	DD	500
B	150	±10%		DEBB33F151KDDB	3150	5.0	6.0	7.5	0.5	DD	500
B	220	±10%		DEBB33F221KDDB	3150	5.0	6.0	7.5	0.5	DD	500
B	330	±10%		DEBB33F331KD3B	3150	6.0	6.0	7.5	0.6	D3	500
B	470	±10%		DEBB33F471KD3B	3150	7.0	6.0	7.5	0.6	D3	500
B	680	±10%		DEBB33F681KB3B	3150	8.0	6.0	7.5	0.6	B3	500
B	1000	±10%		DEBB33F102KB3B	3150	9.0	6.0	7.5	0.6	B3	500
B	1500	±10%		DEBB33F152KB3B	3150	11.0	6.0	7.5	0.6	B3	500
B	2200	±10%		DEBB33F222KB3B	3150	13.0	6.0	7.5	0.6	B3	250
B	3300	±10%		DEBB33F332KB3B	3150	15.0	6.0	7.5	0.6	B3	200
E	1000	+80/-20%		DEBE33D102ZB2B	2000	6.0	5.0	5.0	0.6	B2	500
E	2200	+80/-20%		DEBE33D222ZB2B	2000	8.0	5.0	5.0	0.6	B2	500
E	4700	+80/-20%		DEBE33D472ZB2B	2000	11.0	5.0	5.0	0.6	B2	500
E	10000	+80/-20%		DEBE33D103ZB3B	2000	16.0	5.0	7.5	0.6	B3	200
E	1000	+80/-20%		DEBE33F102ZD3B	3150	7.0	6.0	7.5	0.6	D3	500
E	2200	+80/-20%		DEBE33F222ZB3B	3150	10.0	6.0	7.5	0.6	B3	500

·Vertical crimp short type
(Lead code:B*)



·Straight short type
(Lead code:D*)

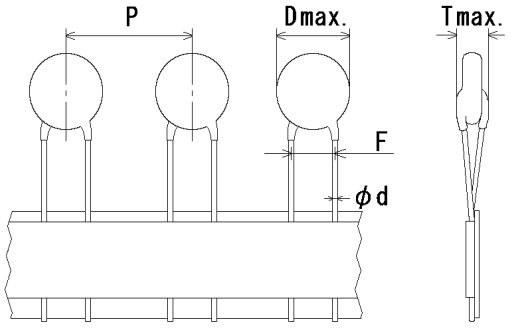


Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

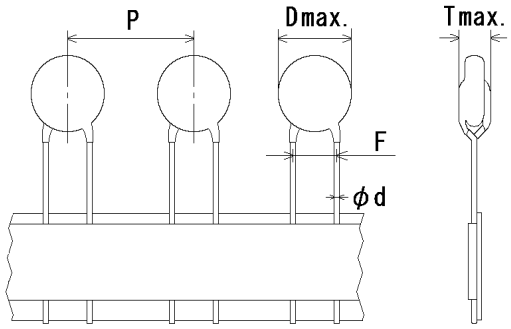
Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated Volt. (V)	Dimension (mm)				Lead Code	Pack qty. (pcs)
						D	T	F	d		
E	4700	+80/-20%		DEBE33F472ZB3B	3150	13.0	6.0	7.5	0.6	B3	250
F	1000	+80/-20%		DEBF33D102ZD1B	2000	5.0	5.0	5.0	0.5	D1	500
F	2200	+80/-20%		DEBF33D222ZB2B	2000	7.0	5.0	5.0	0.6	B2	500
F	4700	+80/-20%		DEBF33D472ZB2B	2000	9.0	5.0	5.0	0.6	B2	500
F	10000	+80/-20%		DEBF33D103ZB3B	2000	12.0	5.0	7.5	0.6	B3	250

·Straight taping type
(Lead code:P*)



·Vartical crimp taping type
(Lead code:N*)

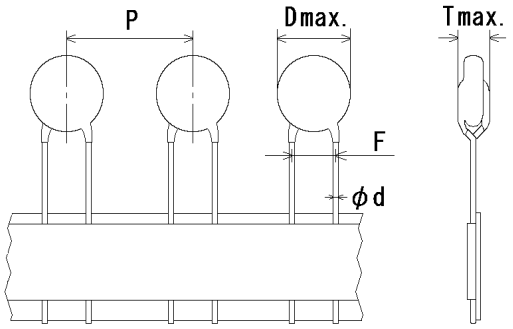


Note) The mark '*' of lead code differ from lead spacing(F), lead diameter(d) and pitch of component(P). Please see the following list or taping specification about details.

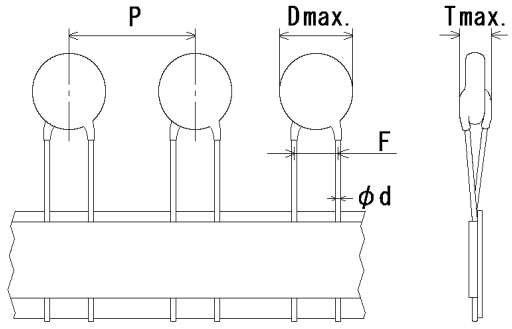
Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated volt. (V)	Dimension (mm)					Lead code	Pack qty. (pcs)
						D	T	F	d	P		
B	100	±10%		DEBB33D101KP2A	2000	4.5	5.0	5.0	0.6	12.7	P2	1500
B	150	±10%		DEBB33D151KP2A	2000	4.5	5.0	5.0	0.6	12.7	P2	1500
B	220	±10%		DEBB33D221KP2A	2000	4.5	5.0	5.0	0.6	12.7	P2	1500
B	330	±10%		DEBB33D331KP2A	2000	5.0	5.0	5.0	0.6	12.7	P2	1500
B	470	±10%		DEBB33D471KN2A	2000	6.0	5.0	5.0	0.6	12.7	N2	1500
B	680	±10%		DEBB33D681KN2A	2000	7.0	5.0	5.0	0.6	12.7	N2	1500
B	1000	±10%		DEBB33D102KN2A	2000	8.0	5.0	5.0	0.6	12.7	N2	1500
B	1500	±10%		DEBB33D152KN2A	2000	9.0	5.0	5.0	0.6	12.7	N2	1500
B	2200	±10%		DEBB33D222KN2A	2000	10.0	5.0	5.0	0.6	12.7	N2	1500
B	3300	±10%		DEBB33D332KN3A	2000	12.0	5.0	7.5	0.6	15.0	N3	900
B	4700	±10%		DEBB33D472KN7A	2000	15.0	5.0	7.5	0.6	30.0	N7	500
B	100	±10%		DEBB33F101KP3A	3150	5.0	6.0	7.5	0.6	15.0	P3	900
B	150	±10%		DEBB33F151KP3A	3150	5.0	6.0	7.5	0.6	15.0	P3	900
B	220	±10%		DEBB33F221KP3A	3150	5.0	6.0	7.5	0.6	15.0	P3	900
B	330	±10%		DEBB33F331KP3A	3150	6.0	6.0	7.5	0.6	15.0	P3	900
B	470	±10%		DEBB33F471KP3A	3150	7.0	6.0	7.5	0.6	15.0	P3	900
B	680	±10%		DEBB33F681KN3A	3150	8.0	6.0	7.5	0.6	15.0	N3	900
B	1000	±10%		DEBB33F102KN3A	3150	9.0	6.0	7.5	0.6	15.0	N3	900
B	1500	±10%		DEBB33F152KN3A	3150	11.0	6.0	7.5	0.6	15.0	N3	900
B	2200	±10%		DEBB33F222KN3A	3150	13.0	6.0	7.5	0.6	15.0	N3	900
B	3300	±10%		DEBB33F332KN7A	3150	15.0	6.0	7.5	0.6	30.0	N7	500
E	1000	+80/-20%		DEBE33D102ZN2A	2000	6.0	5.0	5.0	0.6	12.7	N2	1500
E	2200	+80/-20%		DEBE33D222ZN2A	2000	8.0	5.0	5.0	0.6	12.7	N2	1500
E	4700	+80/-20%		DEBE33D472ZN2A	2000	11.0	5.0	5.0	0.6	12.7	N2	1500
E	10000	+80/-20%		DEBE33D103ZN7A	2000	16.0	5.0	7.5	0.6	30.0	N7	500
E	1000	+80/-20%		DEBE33F102ZP3A	3150	7.0	6.0	7.5	0.6	15.0	P3	900
E	2200	+80/-20%		DEBE33F222ZN3A	3150	10.0	6.0	7.5	0.6	15.0	N3	900

·Vartical crimp taping type
(Lead code:N*)



·Straight taping type
(Lead code:P*)

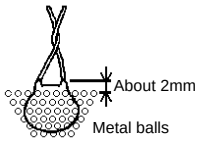


Note) The mark '*' of lead code differ from lead spacing(F), lead diameter(d) and pitch of component(P). Please see the following list or taping specification about details.

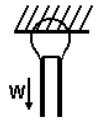
Unit : mm

T.C.	Cap. (pF)	Cap. tol.	Customer Part Number	Murata Part Number	DC Rated volt. (V)	Dimension (mm)					Lead code	Pack qty. (pcs)
						D	T	F	d	P		
E	4700	+80/-20%		DEBE33F472ZN3A	3150	13.0	6.0	7.5	0.6	15.0	N3	900
F	1000	+80/-20%		DEBF33D102ZP2A	2000	5.0	5.0	5.0	0.6	12.7	P2	1500
F	2200	+80/-20%		DEBF33D222ZN2A	2000	7.0	5.0	5.0	0.6	12.7	N2	1500
F	4700	+80/-20%		DEBF33D472ZN2A	2000	9.0	5.0	5.0	0.6	12.7	N2	1500
F	10000	+80/-20%		DEBF33D103ZN3A	2000	12.0	5.0	7.5	0.6	15.0	N3	900

5. Specification and test methods

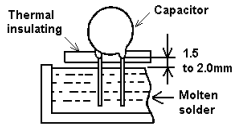
No.	Item		Specification	Test method
1	Appearance and dimensions		No marked defect on appearance form and dimensions. Please refer to [Part number list].	The capacitor should be inspected by naked eyes for visible evidence of defect. Dimensions should be measured with slide calipers.
2	Marking		To be easily legible.	The capacitor should be inspected by naked eyes.
3	Dielectric strength	Between lead wires	No failure.	The capacitor should not be damaged when DC voltage of 200% of the rated voltage are applied between the lead wires for 1 to 5 s. (Charge/Discharge current≤50mA.)
		Body insulation	No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, shortcircuited, is kept about 2mm off the balls as shown in the figure, and DC voltage of 1.3kV is applied for 1 to 5 s between capacitor lead wires and small metals. (Charge/Discharge current≤50mA.) 
4	Insulation Resistance (I.R.)	Between lead wires	10000MΩ min.	The insulation resistance should be measured with DC500±50V within 60±5 s of charging.
5	Capacitance		Within specified tolerance.	The capacitance should be measured at 20°C with 1±0.2kHz and AC5V(r.m.s.) max..
6	Dissipation Factor (D.F.)		Char. B,E : 2.5% max. Char. F : 5.0% max.	The dissipation factor should be measured at 20°C with 1±0.2kHz and AC5V(r.m.s.) max..
7	Temperature characteristic		Char. B : Within ±10% Char. E : Within +20/-55% Char. F : Within +30/-80%	The capacitance measurement should be made at each step specified in Table.
			Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at *room condition for 24±2 h before initial measurements.	

Step	1	2	3	4	5
Temp.(°C)	20±2	-25±3	20±2	85±2	20±2

8	Strength of lead	Pull	Lead wire should not cut off. Capacitor should not be broken.	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N (5N for lead diameter 0.5mm), and keep it for 10±1 s. 
		Bending		Each lead wire should be subjected to 5N (2.5N for lead diameter 0.5mm) of weight and bent 90° at the point of egress, in one direction, then returned to its original position, and bent 90° in the opposite direction at the rate of one bend in 2 to 3 s.
9	Vibration resistance	Appearance	No marked defect.	The capacitor should be firmly soldered to the supporting lead wire and vibrated at a frequency range of 10 to 55Hz, 1.5mm in total amplitude, with about a 1min rate of vibration change from 10Hz to 55Hz and back to 10Hz. Apply for a total of 6 h; 2 h each in 3 mutually perpendicular directions.
		Capacitance	Within specified tolerance.	
		D.F.	Char. B,E : 2.5% max. Char. F : 5.0% max.	
10	Solderability of leads		Lead wire should be soldered with uniformly coated on the axial direction over 3/4 of the circumferential direction.	The lead wire of a capacitor should be dipped into a ethanol solution of 25wt% rosin and then into molten solder for 2±0.5 s. In both cases the depth of dipping is up to about 1.5 to 2mm from the root of lead wires. Temp. of solder : 245±5°C Lead Free Solder (Sn-3Ag-0.5Cu) 235±5°C H63 Eutectic Solder

* "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Reference only

No.	Item		Specification	Test method
11	Soldering effect (Non-preheat)	Appearance	No marked defect.	The lead wire should be immersed into the melted solder of 350±10°C (Body of φ5 and under: 270±5°C) up to about 1.5 to 2.0mm from the main body for 3.5±0.5 s. (Body of φ5 and under: 5±0.5 s.) Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored for 4 to 24 h at * room condition.
		Capacitance change	Char. B : Within ± 5% Char. E : Within ± 15% Char. F : Within ± 20%	
		Dielectric strength (Between lead wires)	Per item 3.	
12	Soldering effect (On-preheat)	Appearance	No marked defect.	First the capacitor should be stored at 120+0/-5°C for 60+0/-5 s. Then, as in figure, the lead wires should be immersed solder of 260+0/-5°C up to 1.5 to 2.0mm from the root of terminal for 7.5+0/-1 s.  Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored for 4 to 24 h at * room condition.
		Capacitance change	Char. B : Within ± 5% Char. E : Within ± 15% Char. F : Within ± 20%	
		Dielectric strength (Between lead wires)	Per item 3.	
13	Humidity (Under steady state)	Appearance	No marked defect.	Set the capacitor for 500 +24/-0 h at 40±2°C in 90 to 95% relative humidity. Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored for 1 to 2 h at * room condition.
		Capacitance change	Char. B : Within ±10% Char. E : Within ±20% Char. F : Within ±30%	
		D.F.	Char. B,E : 5.0% max. Char. F : 7.5% max.	
		I.R.	1000MΩ min.	
14	Humidity loading	Appearance	No marked defect.	Apply the rated voltage for 500 +24/-0 h at 40±2°C in 90 to 95% relative humidity. (Charge/Discharge current≤50mA.) Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h.
		Capacitance change	Char. B : Within ±10% Char. E : Within ±20% Char. F : Within ±30%	
		D.F.	Char. B,E : 5.0% max. Char. F : 7.5% max.	
		I.R.	500MΩ min.	
15	Life	Appearance	No marked defect.	Apply a DC voltage of 150% of the rated voltage for 1000 +48/-0 h at 85±2°C, and relative humidity of 50% max.. (Charge/Discharge current≤50mA.) Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h before initial measurements. Post-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h.
		Capacitance change	Char. B : Within ±10% Char. E : Within ±20% Char. F : Within ±30%	
		D.F.	Char. B,E : 4.0% max. Char. F : 7.5% max.	
		I.R.	2000MΩ min.	

* "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Reference only

<table>
<tr><th>No.</th><th colspan="2">Item</th><th>Specification</th><th>Test method</th></tr>
<tr><td rowspan="4">16</td><td rowspan="4">Temperature and Immersion cycle</td><td>Appearance</td><td>No marked defect.</td><td rowspan="4">The capacitor should be subjected to
5 temperature cycles, then consecutively to
2 immersion cycles.
<Temperature cycle>
<table><tr><th>Step</th><th>Temperature(°C)</th><th>Time</th></tr><tr><td>1</td><td>-25±3</td><td>30 min</td></tr><tr><td>2</td><td>Room Temp.</td><td>3 min</td></tr><tr><td>3</td><td>+85±3</td><td>30 min</td></tr><tr><td>4</td><td>Room Temp.</td><td>3 min</td></tr></table>Cycle time : 5 cycle
<Immersion cycle>
<table><tr><th>Step</th><th>Temperature(°C)</th><th>Time</th><th>Immersion water</th></tr><tr><td>1</td><td>+65+5/-0</td><td>15 min</td><td>Clean water</td></tr><tr><td>2</td><td>0±3</td><td>15 min</td><td>Salt water</td></tr></table>Cycle time : 2 cycle
Pre-treatment : Capacitor should be stored at 85±2°C for 1 h, then placed at * room condition for 24±2 h before initial measurements.
Post-treatment : Capacitor should be stored for 4 to 24 h at * room condition.</td></tr>
<tr><td>Capacitance change</td><td>Char. B : Within ±10%
Char. E : Within ±20%
Char. F : Within ±30%</td></tr>
<tr><td>D.F.</td><td>Char. B,E : 4.0% max.
Char. F : 7.5% max.</td></tr>
<tr><td>I.R.</td><td>2000MΩ min.</td></tr>
<tr><td>Dielectric strength (Between lead wires)</td><td>Per item 3.</td></tr>
</table>

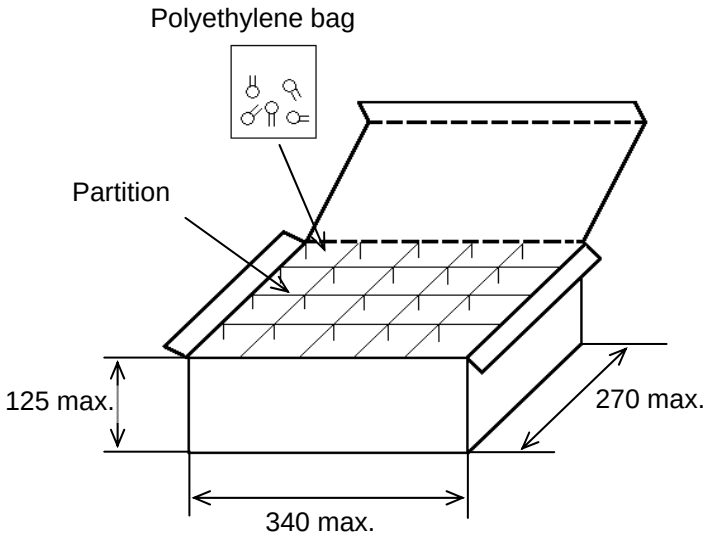
* "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

6.Packing specification

•Bulk type (Packing style code : B)

The number of packing = $\overset{*1}{\text{Packing quantity}} \times \overset{*2}{n}$

The size of packing case and packing way



Unit : mm

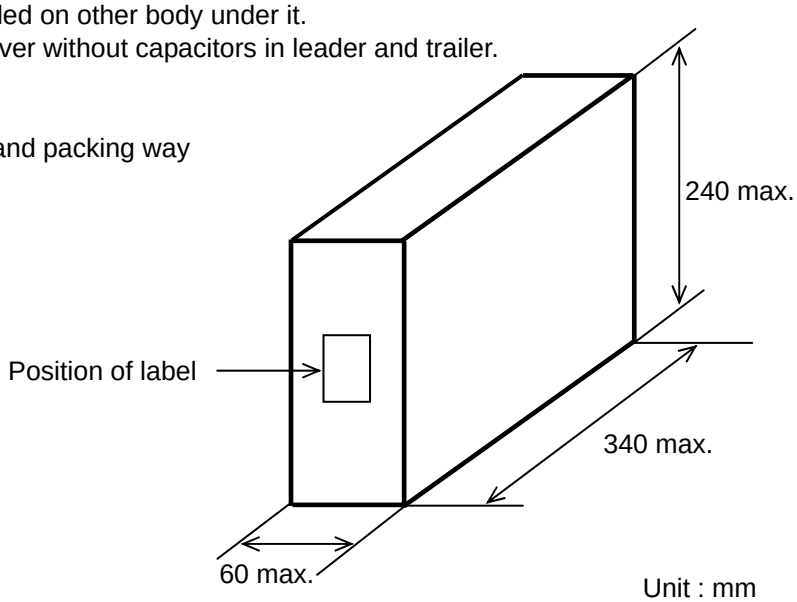
∗1 : Please refer to [Part number list].
∗2 : Standard n = 20 (bag)

Note)
The outer package and the number of outer packing be changed by the order getting amount.

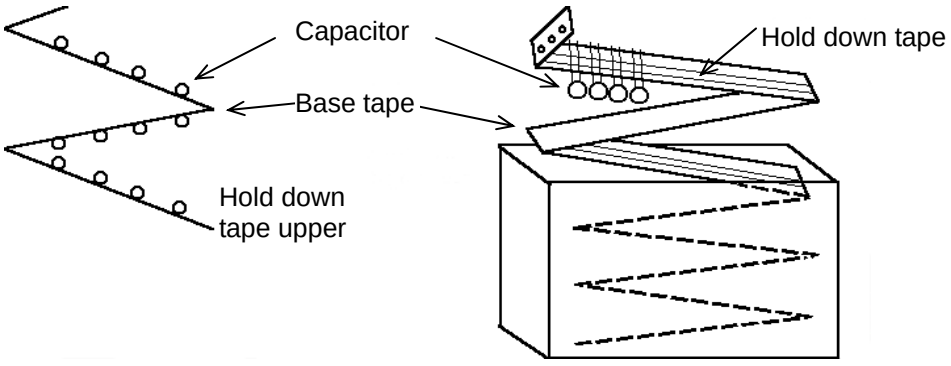
•Ammo pack taping type (Packing style code : A)

· The tape with capacitors is packed zigzag into a case.
· When body of the capacitor is piled on other body under it.
· There should be 3 pitches and over without capacitors in leader and trailer.

The size of packing case and packing way



Unit : mm

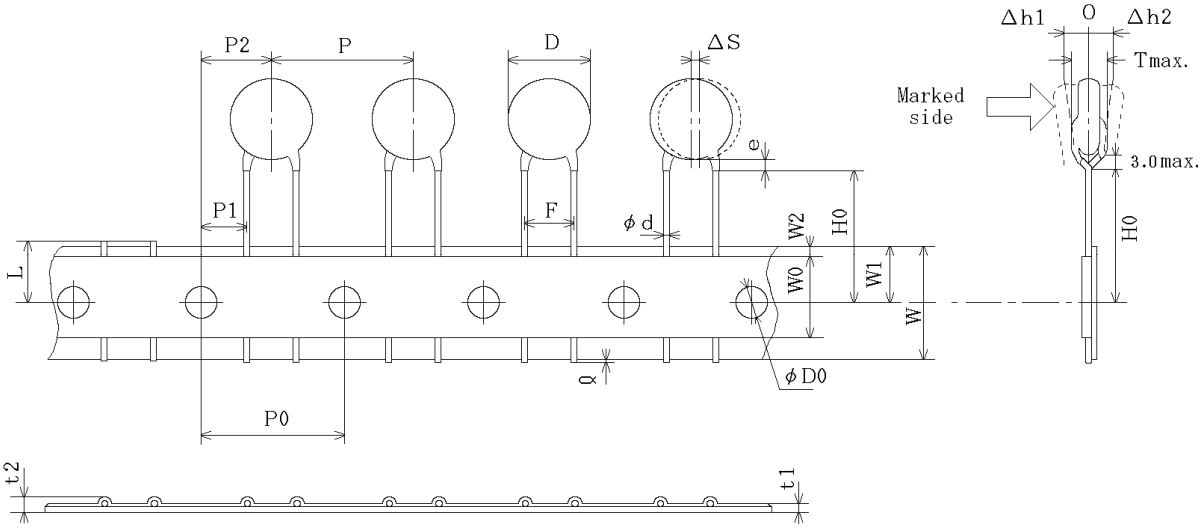


7. Taping specification

7-1. Dimension of capacitors on tape

Vertical crimp taping type < Lead code : N2 >

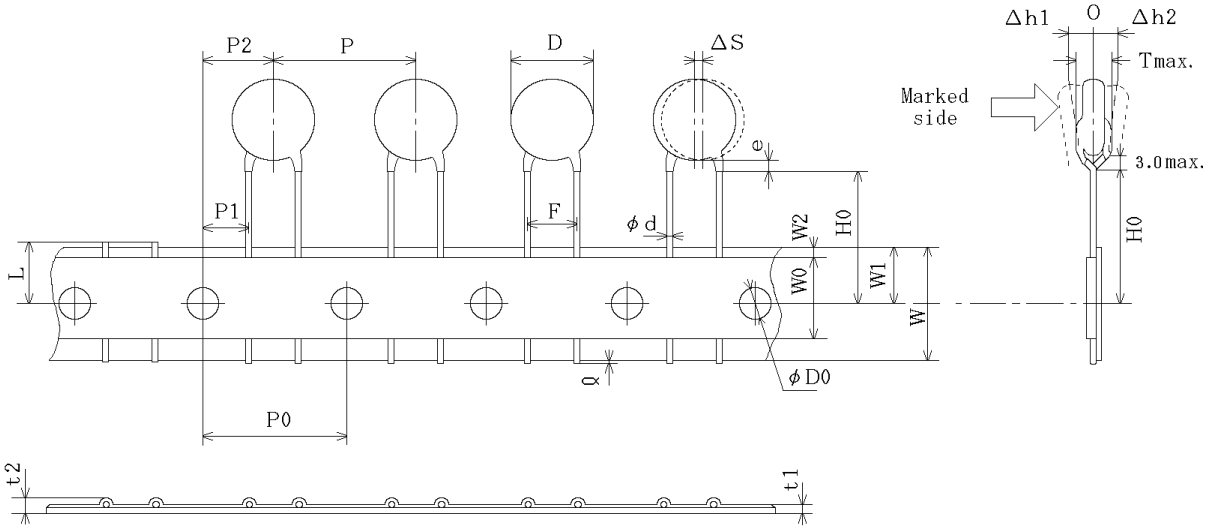
Pitch of component 12.7mm / Lead spacing 5.0mm



Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	12.7±1.0	
Pitch of sprocket hole	P0	12.7±0.3	
Lead spacing	F	$5.0^{+0.8}_{-0.2}$	
Length from hole center to component center	P2	6.35±1.3	Deviation of progress direction
Length from hole center to lead	P1	3.85±0.7	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±1.0	They include deviation by lead bend .
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H0	$18.0^{+2.0}_{-0}$	
Protrusion length	Q	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	1.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0^{+0}_{-1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	Up to the end of crimp	
Body thickness	T	Please refer to [Part number list].	

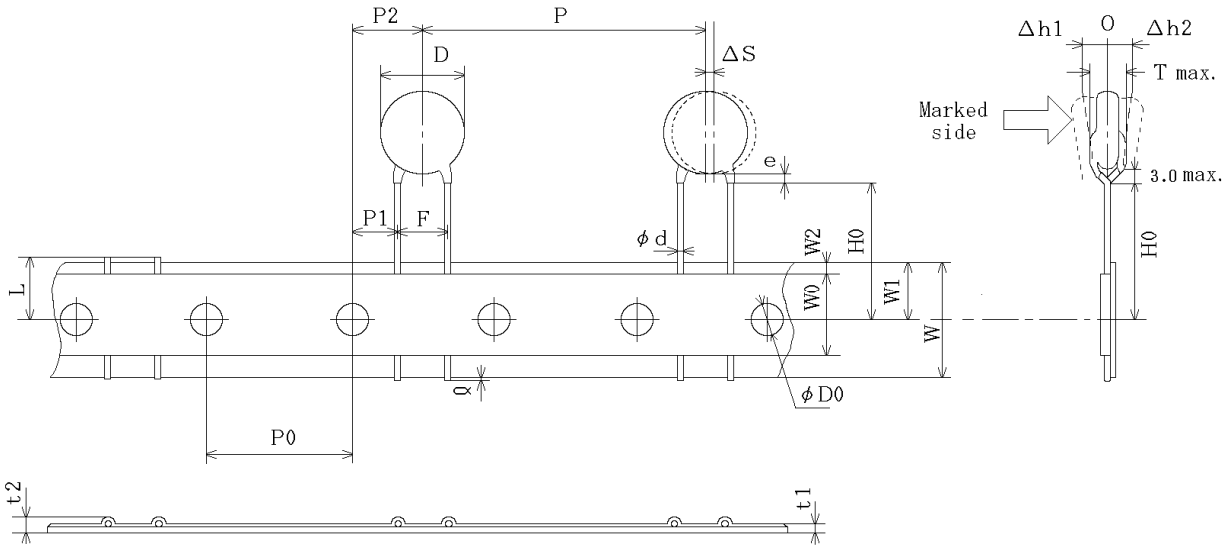
Vertical crimp taping type < Lead code : N3 >
Pitch of component 15.0mm / Lead spacing 7.5mm



Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	15.0±2.0	
Pitch of sprocket hole	P0	15.0±0.3	
Lead spacing	F	7.5±1.0	
Length from hole center to component center	P2	7.5±1.5	Deviation of progress direction
Length from hole center to lead	P1	3.75±1.0	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±2.0	They include deviation by lead bend .
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H0	$18.0\pm^{2.0}_{0}$	
Protrusion length	α	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	2.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0\pm^{0}_{1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	Up to the end of crimp	
Body thickness	T	Please refer to [Part number list].	

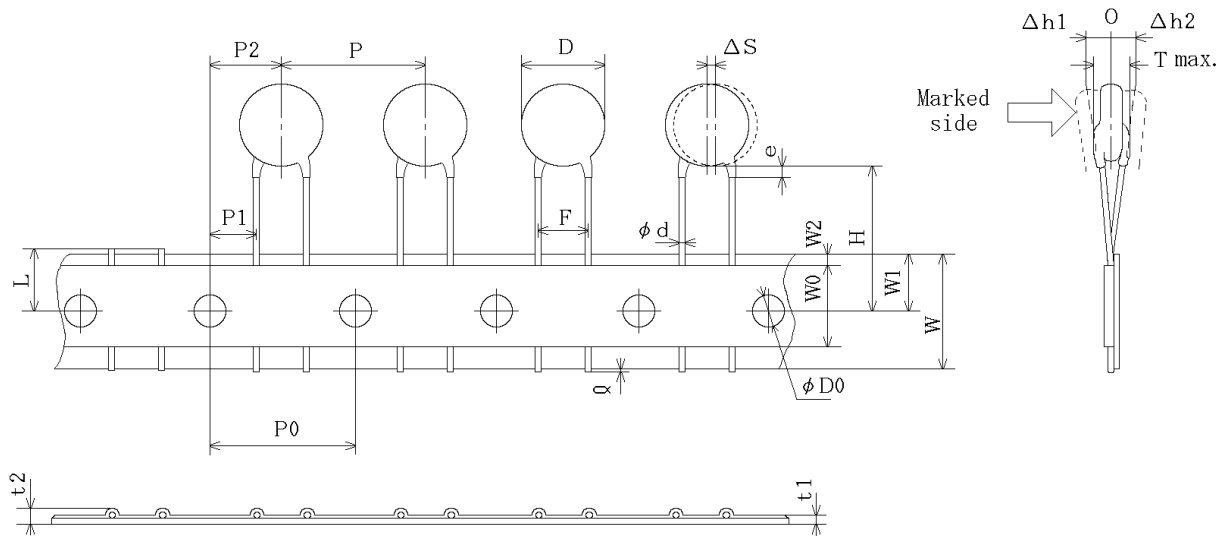
Vertical crimp taping type < Lead code : N7 >
Pitch of component 30.0mm /Lead spacing 7.5mm



Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	30.0±2.0	
Pitch of sprocket hole	P0	15.0±0.3	
Lead spacing	F	7.5±1.0	
Length from hole center to component center	P2	7.5±1.5	Deviation of progress direction
Length from hole center to lead	P1	3.75±1.0	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±2.0	They include deviation by lead bend.
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H0	$18.0\pm^{2.0}_{0}$	
Protrusion length	Q	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	2.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0\pm^{0}_{1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	Up to the end of crimp	
Body thickness	T	Please refer to [Part number list].	

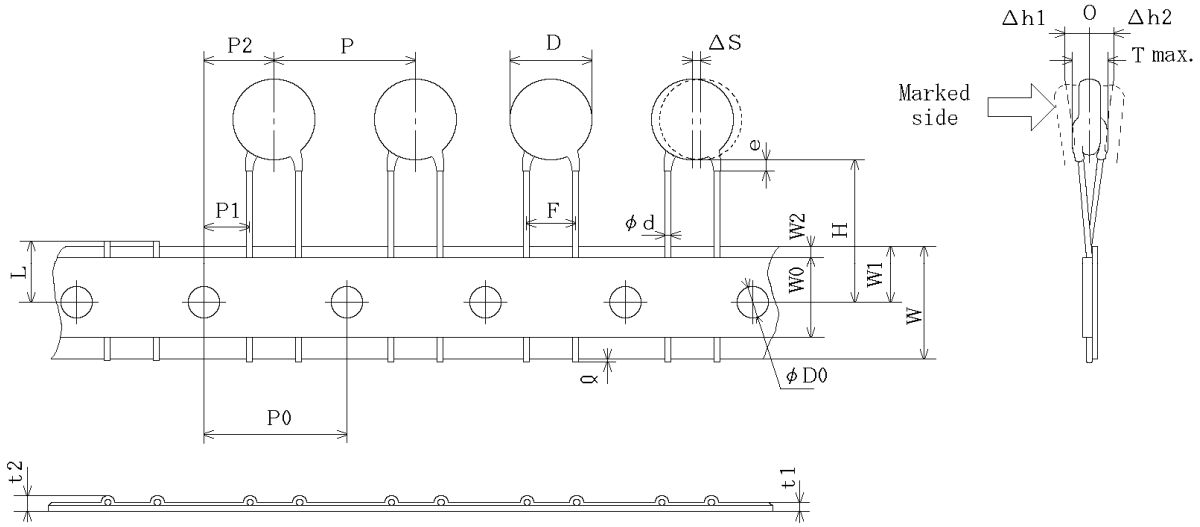
Straight taping type < Lead code: P2 >
Pitch of component 12.7mm / Lead spacing 5.0mm



Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	12.7±1.0	
Pitch of sprocket hole	P0	12.7±0.3	
Lead spacing	F	$5.0^{+0.8}_{-0.2}$	
Length from hole center to component center	P2	6.35±1.3	Deviation of progress direction
Length from hole center to lead	P1	3.85±0.7	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±1.0	They include deviation by lead bend .
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H	$20.0^{+1.5}_{-1.0}$	
Protrusion length	Q	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	1.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0^{+0}_{-1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	3.0 max.	
Body thickness	T	Please refer to [Part number list].	

Straight taping type < Lead code : P3 >
Pitch of component 15.0mm / Lead spacing 7.5mm

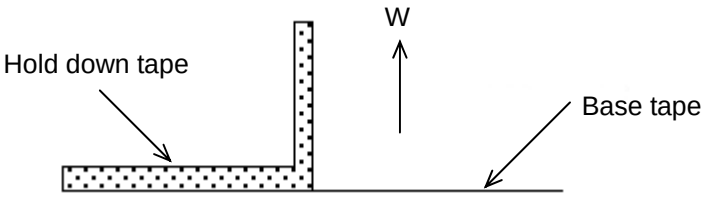


Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	15.0±2.0	
Pitch of sprocket hole	P0	15.0±0.3	
Lead spacing	F	7.5±1.0	
Length from hole center to component center	P2	7.5±1.5	Deviation of progress direction
Length from hole center to lead	P1	3.75±1.0	
Body diameter	D	Please refer to [Part number list].	
Deviation along tape, left or right	ΔS	0±2.0	They include deviation by lead bend .
Carrier tape width	W	18.0±0.5	
Position of sprocket hole	W1	9.0±0.5	Deviation of tape width direction
Lead distance between reference and bottom planes	H	$20.0\pm^{1.5}_{1.0}$	
Protrusion length	Q	+0.5~−1.0	
Diameter of sprocket hole	φD0	4.0±0.1	
Lead diameter	φd	0.60±0.05	
Total tape thickness	t1	0.6±0.3	They include hold down tape thickness.
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape, front	Δh1	2.0 max.	
Deviation across tape, rear	Δh2		
Portion to cut in case of defect	L	$11.0\pm^{0}_{1.0}$	
Hold down tape width	W0	11.5 min.	
Hold down tape position	W2	1.5±1.5	
Coating extension on lead	e	3.0 max.	
Body thickness	T	Please refer to [Part number list].	

7-2. Splicing way of tape

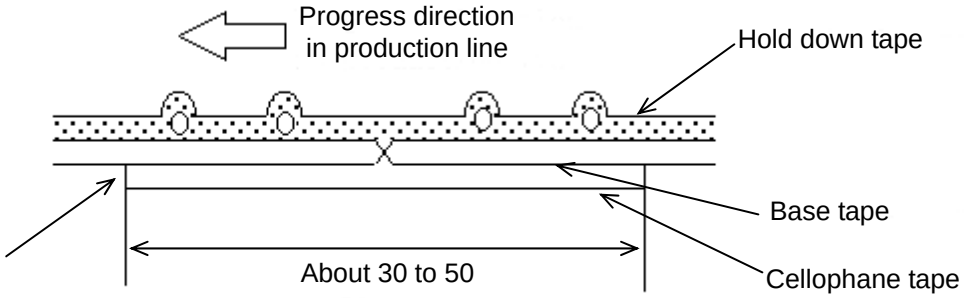
1) Adhesive force of tape is over 3N at test condition as below.



2) Splicing of tape

a) When base tape is spliced

- Base tape should be spliced by cellophane tape.
  (Total tape thickness should be less than 1.05mm.)

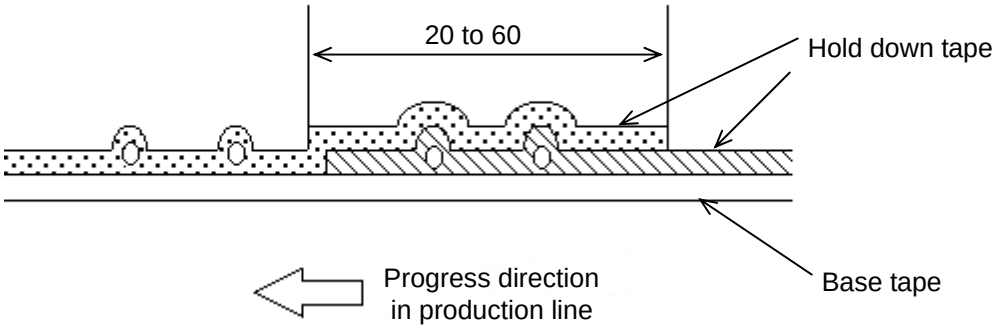


No lifting for the direction of progressing

Unit : mm

b) When hold down tape is spliced

- Hold down tape should be spliced with overlapping.
  (Total tape thickness should be less than 1.05mm.)



Unit : mm

c) When both tape are spliced

- Base tape and hold down tape should be spliced with splicing tape.

3) Missing components

- There should be no consecutive missing of more than three components.
- The number of missing components should be not more than 0.5% of total components that should be present in a Ammo pack.

EU RoHS

This products of the following crresponds to EU RoHS.

RoHS

maximum concentration values tolerated by weight in homogeneous materials

- 1000 ppm maximum Lead
- 1000 ppm maximum Mercury
- 100 ppm maximum Cadmium
- 1000 ppm maximum Hexavalent chromium
- 1000 ppm maximum Polybrominated biphenyls (PBB)
- 1000 ppm maximum Polybrominated diphenyl ethers (PBDE)